

RESPONSE UNDER 37 CFR 1.116
EXPEDITED PROCEDURE
EXAMINING GROUP 2811

PATENT APPLICATION
Docket No.: 9903-068
Client Ref. No.: S03US008

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Dae-Woo SON, et al.

Serial No.: 10/739,456 Examiner: Owens, Douglas W.

Filed: December 17, 2003 Group Art Unit: 2811

Confirmation No.: 9321

For: TAPE CIRCUIT SUBSTRATE HAVING WAVY BEAM LEADS
AND SEMICONDUCTOR CHIP PACKAGE USING THE SAME

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AFTER FINAL REJECTION UNDER 37 CFR 1.116

Responsive to the Final Office Action, Paper No. 20060310, dated March 16, 2006,
please amend the application as follows.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3
of this paper.

Remarks/Arguments begin on page 9 of this paper.